Quad 2-input NOR gate Rev. 1 — 4 April 2013

Product data sheet

#### 1. **General description**

The 74LVC02A-Q100 provides four 2-input NOR gates.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V applications.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

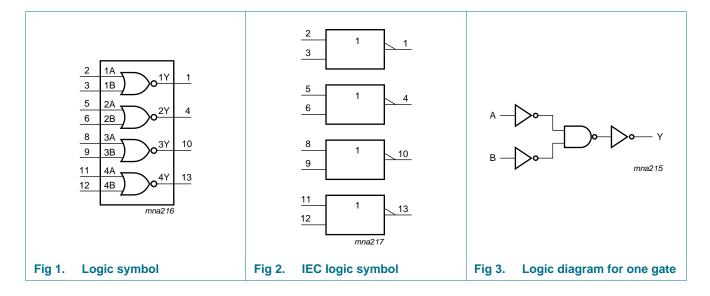
- Automotive product qualification in accordance with AEC-Q100 (Grade 1) Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options



### 3. Ordering information

Table 1.         Ordering information							
Type number	Package						
	Temperature range	Name	Description	Version			
74LVC02AD-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			
74LVC02APW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LVC02ABQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1			

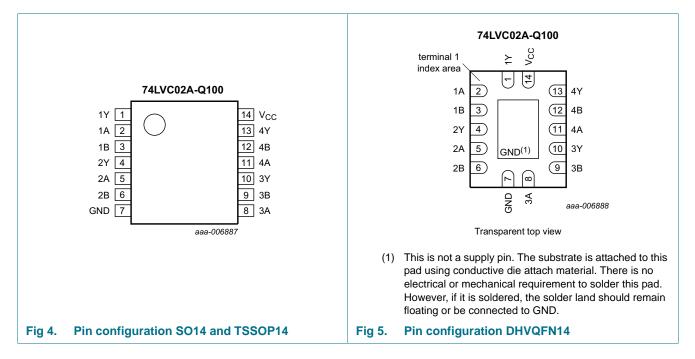
### 4. Functional diagram





### 5. Pinning information

### 5.1 Pinning



#### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1Y to 4Y	1, 4, 10, 13	data output
1A to 4A	2, 5, 8, 11	data input
1B to 4B	3, 6, 9,12	data input
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

### 6. Functional description

Table 3.         Function table <sup>[1]</sup>		
Input nA	Input nB	Output nY
L	L	Н
Х	Н	L
Н	Х	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

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### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output in HIGH or LOW-state	[2] -0.5	V <sub>CC</sub> + 0.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[3] _	500	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO14 packages: above 70 °C derate linearly with 8 mW/K.
 For TSSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC}$ = 2.7 V to 3.6 V	0	-	10	ns/V

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### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	–40 °C to	o +125 ℃	Uni
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC}$ = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
	$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_{O}$ = 4 mA; $V_{CC}$ = 1.65 V	-	-	0.45	-	0.65	V
		$I_{O}$ = 8 mA; $V_{CC}$ = 2.3 V	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
1	input leakage current	$V_{CC}$ = 3.6 V; $V_{I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA
lcc	supply current	$\label{eq:VCC} \begin{array}{l} V_{CC} = 3.6 \ \text{V}; \ \text{V}_{\text{I}} = \text{V}_{CC} \ \text{or GND}; \\ \text{I}_{O} = 0 \ \text{A} \end{array}$	-	0.1	10	-	40	μA
∆l <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>	-	4.0	-	-	-	pF

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

### **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nA, nB to nY; see Figure 6	[2]						
	V <sub>CC</sub> = 1.2 V		-	14	-	-	-	ns	
	$V_{CC}$ = 1.65 V to 1.95 V		0.5	4.0	8.6	0.5	10.1	ns	
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.4	4.9	1.0	5.7	ns
		$V_{CC} = 2.7 V$		1.0	2.5	5.1	1.0	6.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.2	4.4	1.0	5.5	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC}$ = 3.0 V to 3.6 V	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation	per gate; $V_I = GND$ to $V_{CC}$	[4]						
	capacitance	$V_{CC}$ = 1.65 V to 1.95 V		-	2.5	-	-	-	ns ns ns ns
		$V_{CC}$ = 2.3 V to 2.7 V		-	5.7	-	-	-	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	8.5	-	-	-	pF

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

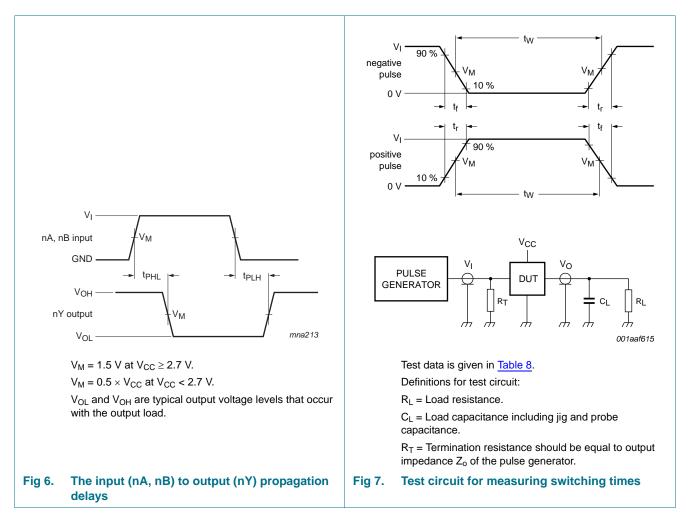
 $V_{CC}$  = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

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### 11. AC waveforms

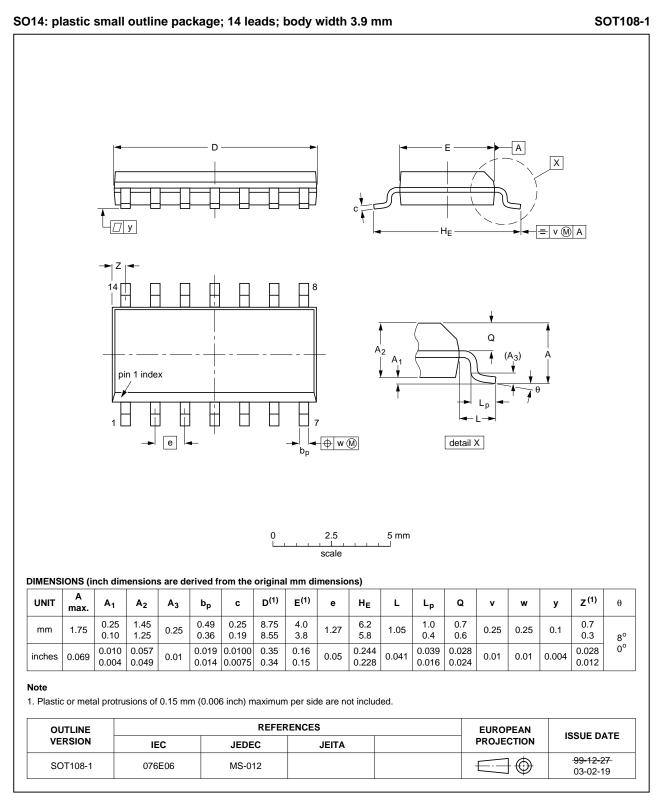


#### Table 8. Test data

Supply voltage	Input		Load		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	

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### 12. Package outline

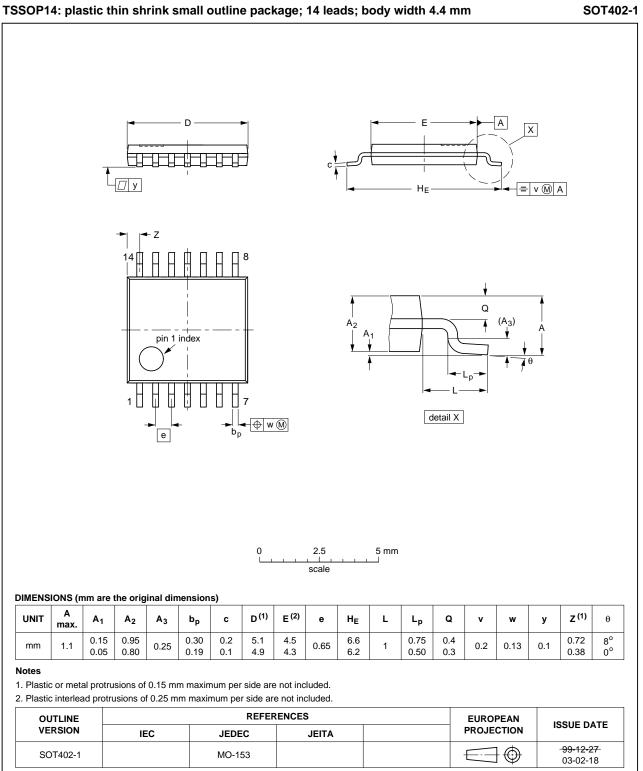


#### Fig 8. Package outline SOT108-1 (SO14)

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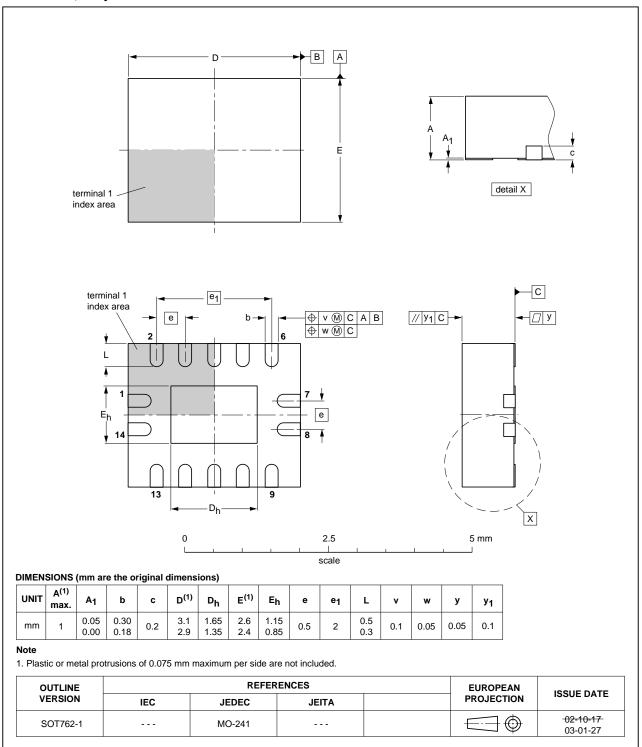
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Package outline SOT402-1 (TSSOP14) Fig 9.

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; SOT762-1 14 terminals; body 2.5 x 3 x 0.85 mm

#### Fig 10. Package outline SOT762-1 (DHVQFN14)

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### **13. Abbreviations**

Table 9.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

Table 10. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC02A_Q100 v.1	20130404	Product data sheet	-	-	

### **15. Legal information**

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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